Notification Number:	2022032800	02.0	Notification D	ate:	April 27, 2022	
Title: Datasheet for	TPS25947xx					
Customer Contact: PCN Manager				Dept	Dept: Quality Services	
Change Type:						
Assembly Site	□ D	esign		V	Vafer Bump Site	
Assembly Process	∑ D			V	Vafer Bump Material	
		art numbe	number change		Vafer Bump Process	
		est Site			Vafer Fab Site	
Packing/Shipping/Labeling Tes		est Process			Vafer Fab Materials	
				L V	Vafer Fab Process	
	Noti	ificatior	n Details			
Description of Change: Texas Instruments Incorp						
The product datasheet(s) The following change hist TEXAS INSTRUMENTS			ils.		TPS25947	
Changes from Revision A					CTOBER 2020 – REVISED MARCH 2022	
Corrected the ESD RatinUpdated image formattin	gs to show CDM te	sting was pe	er JS-002			
Device Family			Change From:		Change To:	
,				9A SLVSFC9B		
TPS25947xx		SLVS	SFC9A	SL	VSFC9B	
TPS25947xx These changes may be renttp://www.ti.com/produ				SI	VSFC9B	
These changes may be renttp://www.ti.com/produ				Sl	VSFC9B	
hese changes may be renttp://www.ti.com/produ	ct/TPS25947	atasheet l		Sl	VSFC9B	
These changes may be reattp://www.ti.com/productions/p	ce characteristic	atasheet I	links provided.	oility (positive / negative):	
These changes may be reattp://www.ti.com/producteson for Change: To accurately reflect device. To anticipated impact on the actual device.	ce characteristic Fit, Form, Fundation is a specificat	atasheet I	links provided. ality or Relial ge announceme	pility (nt only	positive / negative): v. There are no changes	
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These changes may be renttp://www.ti.com/produ Reason for Change: To accurately reflect devi Anticipated impact on No anticipated impact. The the actual device. Changes to product ide None.	ce characteristic Fit, Form, Fundation is a specificat	atasheet I	links provided. ality or Relial ge announceme	pility (nt only	positive / negative): v. There are no changes	
These changes may be re	ce characteristic Fit, Form, Fundation is a specificat	atasheet I	links provided. ality or Relial ge announceme	oility (nt only cation	positive / negative): v. There are no changes	

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	PCN www admin_team@list.ti.com

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